The high count-rate self-triggering Silicon Tracking System of the CBM experiment at FAIR – design, series assembly, upgrade options –

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The Compressed Baryonic Matter (CBM) experiment at FAIR



set-up in electronhadron configuration

HADES detector for separate running

1: Time-Zero Detector & Beam Diagnostics 2: Silicon Tracking System / Micro Vertex Detector 3: Superconducting Dipole Magnet 4: Muon Chambers

5: Ring Imaging Cherenkov Detector 6: Transition Radiation Detector 7: Time of Flight Detector 8: Forward Spectator Detector

Physics aim

- Exploration of the QCD phase diagram at high densities and baryon moderate net temperatures
- Starting with SIS100 projectile energies: 2 ÷ 11 GeV/nucleon = $\sqrt{s_{NN}}$ = 2.7 ÷ 4.9 GeV, protons up to 29 GeV

Observables

- Hadrons, electrons, muons, photons
- Particle yields and multi-differential crosssections
- Rare diagnostic probes: strange mesons, light vector mesons (ρ , ω , ϕ), charm production

Challenges in QCD matter physics – The scientific programme of the CBM experiment at FAIR



STS in the gap of the superconducting dipole magnet



central Au+Au, 8 GeV/nucleon

The Silicon Tracking System (STS)

- pile-up free track point determination in high-rate collision environment: $10^{5} - 10^{7}$ /s (A+A), up to 10^{9} /s (p+A)
- **physics aperture:** $2.5^{\circ} \le \Theta \le 25^{\circ}$
- 8 tracking stations in 1 Tm dipole magnetic field, distance from target: 0.3 m \div 1.0 m
- hit spatial resolution $\approx 15 \, \mu m$
- self-triggering front-end electronics, data streaming to compute farm for on-line track and event determination
- time-stamp resolution ≈ 5 ns
- **•** material budget: $0.3\% X_0 \div 1.4\% X_0$ per station
- **momentum res.**: $\Delta p/p \approx 1.8\%$ (p > 1 GeV/c)



p+C, 29 GeV few charged particles/collision up to 10⁹ collisions/s

Eur. Phys. J. A 53, 60 (2017), https://doi.org/10.1140/epja/i2017-12248-y

~ 350 charged particles/collision $10^5 - 10^7$ collisions/s

Design and Integration







Read-out Electronics, Data Acquisition Chain

Modules and Ladders – Series Assembly



tab-bonding of Al-polyimide micro cables between sensor and ASICs/front-end boards



performance of 26 modules, first three series ladders



mSTS Demonstrator in mCBM @ SIS18

• 12 modules on 6 detector ladders mSTS • arranged on 5 mechanical units (1% of full STS) • forming a system of 3 tracking stations



(prototype) components meet specifications:

- time resolution
- 4.8 9.2 ns
- hit spatial resolution
- 10 µm hit reconstruction

efficiency > 97%

mCBM

full-system demonstrator with prototype/pre-series **CBM** components: BMON, STS, MUCH, TRD, TOF, RICH, FSD, DAQ/FLES



presented at

Functional characterization of modules for the Silicon Tracking System of the CBM experiment, Nucl. Instr. Meth. Phys. Res. A1059 (2024), https://doi.org/10.1016/j.nima.2023.168813

mCBM benchmark rare signal reconstructed: $\Lambda \rightarrow p \pi^{-1}$

Ni+Ni 1.93 GeV/u (May 2022), 10⁹ collisions, 400 kHz av. coll. rate

- all detector systems involved
- secondary vertex detection
- 1.1 1.15 1.2 1.25 M_{inv} [GeV] • velocity windows for p and π^{-} candidate





"First Λ Baryons for CBM." Nuclear Physics News, 33(2), pp. 36–37 https://doi.org/10.1080/10619127.2023.2198920

Upgrade Options

The STS system design with its largely independent upstream and downstream construction blocks

- allows for facilitated maintenance + repair • or to upgrade e.g. the higher irradiated
- detector parts after the nominal end-of life criterion of 10¹⁴ $n_{equiv. 1 MeV} cm^{-2}$

Detailed requirements are to be determined by CBM physics workgroups. Candidate detector technologies for running beyond the baseline program are, e.g.:

- monolithic active pixel sensors
- self-triggering
- time-resolution and data throughput same or better than the current STS
- system integration compatibility with large-area coverage

Institutes:

STS Project

2013 –	Technical Design Report	

- 2019 2021 Sensor Production
- 2020 2023 FEE Production

Timeline:

- 2024 2025 Production of Mechanics
- 2023 2026 STS Detector Construction
- 2026 Ready for installation into CBM

Germany: GSI-FAIR, Tübingen Univ., Goethe Univ., KIT AGH, JU, WUT Poland: KINR Ukraine: KEK (assoc.) Japan:

Assembly Centers: GSI-FAIR, KIT



PISA2024 – 16th Pisa Meeting on Advanced Detectors, La Biodola - Isola d'Elba, Italy, 26 May – 1 June 2024